

2SK3525-01MR

FUJI POWER MOSFET

Super FAP-G Series

N-CHANNEL SILICON POWER MOSFET

■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

■ Maximum ratings and characteristic

● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	600	V
Continuous drain current	Id	± 6	A
Pulsed drain current	Id(puls)	± 24	A
Gate-source voltage	VGS	± 30	V
Repetitive or non-repetitive	IAR *2	6	A
Maximum Avalanche Energy	EAS *1	193	mJ
Maximum Drain-Source dV/dt	dVDS/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	Pd	2.16	W
	Ta=25°C		
	Tc=25°C	58	
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C

*1 L=9.83mH, Vcc=60V *2 Tch≤150°C *3 If≤ -Id, -di/dt=50A/μs, Vcc≤BVdss, Tch≤150°C

*4 VDS≤600V

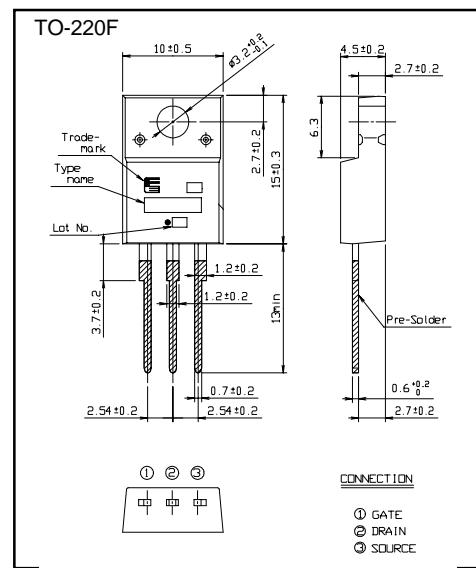
● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=250μA VGS=0V	600			V
Gate threshold voltage	VGS(th)	Id=250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	bss	VDS=600V VGS=0V		25		μA
		T _h =25°C				
		VDS=480V VGS=0V		250		
		T _h =125°C				
Gate-source leakage current	IGSS	VGS=±30V VDS=0V	10	100		nA
Drain-source on-state resistance	RDS(on)	Id=3A VGS=10V	0.93	1.20		Ω
Forward transconductance	gfs	Id=3A VDS=25V	3	6		S
Input capacitance	Ciss	VDS=25V	750	1130		pF
Output capacitance	Coss	VGS=0V	100	150		
Reverse transfer capacitance	Crss	f=1MHz	4.0	6.0		
Turn-on time t _{on}	td(on)	Vcc=300V Id=3A	14	21		ns
	tr	VGS=10V	9	14		
Turn-off time t _{off}	td(off)	RGS=10Ω	24	36		
	tf		7	10.5		
Total Gate Charge	QG	Vcc=300V	20	30		nC
Gate-Source Charge	QGS	Id=6A	8.5	13		
Gate-Drain Charge	QGD	VGS=10V	5.5	8.5		
Avalanche capability	Iav	L=9.83mH T _h =25°C	6			A
Diode forward on-voltage	VSD	If=6A VGS=0V T _h =25°C	1.00	1.50		V
Reverse recovery time	trr	If=6A VGS=0V	0.7			μs
Reverse recovery charge	Qrr	-di/dt=100A/μs T _h =25°C	3.5			μC

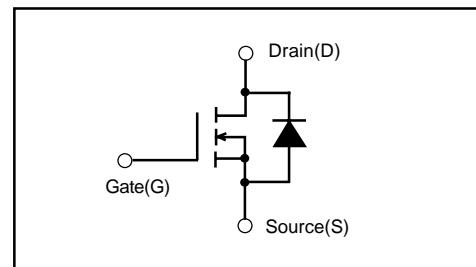
● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			2.16	°C/W
	Rth(ch-a)	channel to ambient			35.0	°C/W

■ Outline Drawings



■ Equivalent circuit schematic



■ Characteristics

